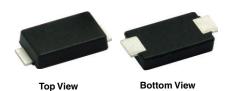
HALOGEN FREE



## Vishay General Semiconductor

# **Surface Mount Trench MOS Barrier Schottky Rectifier**

### TMBS® SlimSMATM



**DO-221AC** 

PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	5.0 A		
V <sub>RRM</sub>	100 V		
I <sub>FSM</sub>	100 A		
V <sub>F</sub> at I <sub>F</sub> = 5.0 A (125 °C)	0.62 V		
T <sub>J</sub> max.	175 °C		
Package	DO-221AC (SlimSMA)		
Diode variation	Single die		

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

#### **MECHANICAL DATA**

Case: DO-221AC (SlimSMA)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	VSSAF5M10	UNIT	
Device marking code		5M10		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	100	V	
Maximum DC forward current	I <sub>F(AV)</sub> (1)	2.6	^	
	I <sub>F(AV)</sub> (2)	5.0	A	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub> 100		А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +175	°C	

#### **Notes**

- (1) Free air, mounted on recommended copper pad area
- (2) Mounted on 30 mm x 30 mm pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I <sub>F</sub> = 2.5 A	T <sub>A</sub> = 25 °C	V <sub>E</sub> (1)	0.59	-	V	
	I <sub>F</sub> = 5.0 A			0.71	0.79		
	I <sub>F</sub> = 2.5 A	- T <sub>A</sub> = 125 °C	T _ 105 °C	-'	0.51	-	V
	I <sub>F</sub> = 5.0 A			0.62	0.7		
Reverse current	V <sub>R</sub> = 70 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	0.01	-	- mA	
		T <sub>A</sub> = 125 °C		0.8	-		
	V <sub>R</sub> = 100 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	-	0.4	- mA	
		T <sub>A</sub> = 125 °C		1.5	4		
Typical junction capacitance	4.0 V, 1 MHz		CJ	470	-	pF	

#### Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)				
PARAMETER	SYMBOL	VSSAF5M10	UNIT	
Typical thermal resistance	R <sub>θJA</sub> (1)(2)	115	°C/W	
	R <sub>0JM</sub> (3)	12	C/VV	

#### Notes

<sup>(1)</sup> Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient,  $R_{\theta JM}$  - junction to mount

 $^{(2)}$  The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/DT_J < 1/R_{\theta JA}$ 

(3) Mounted on 30 mm x 30 mm pad area

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
VSSAF5M10-M3/H	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF5M10-M3/I	0.032	1	14 000	13" diameter plastic tape and reel	
VSSAF5M10HM3/H (1)	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF5M10HM3/I (1)	0.032	I	14 000	13" diameter plastic tape and reel	

#### Note

(1) AEC-Q101 qualified



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### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

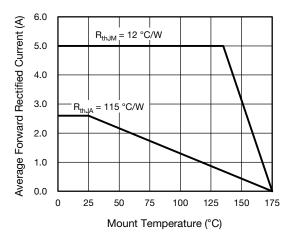


Fig. 1 - Maximum Forward Current Derating Curve

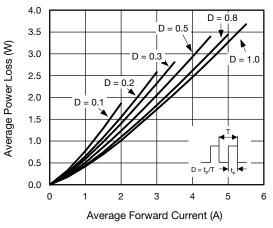


Fig. 2 - Forward Power Loss Characteristics

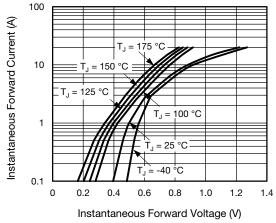


Fig. 3 - Typical Instantaneous Forward Characteristics

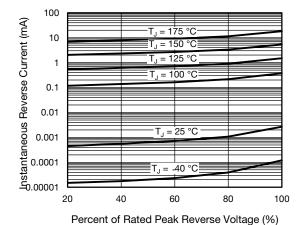


Fig. 4 - Typical Reverse Leakage Characteristics

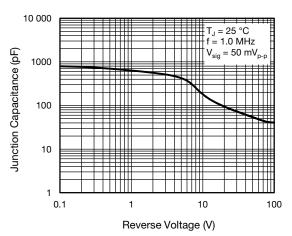


Fig. 5 - Typical Junction Capacitance

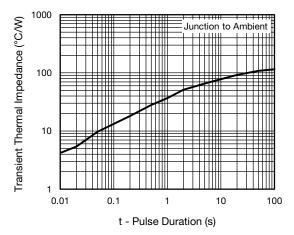


Fig. 6 - Typical Transient Thermal Impedance



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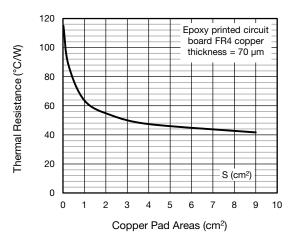
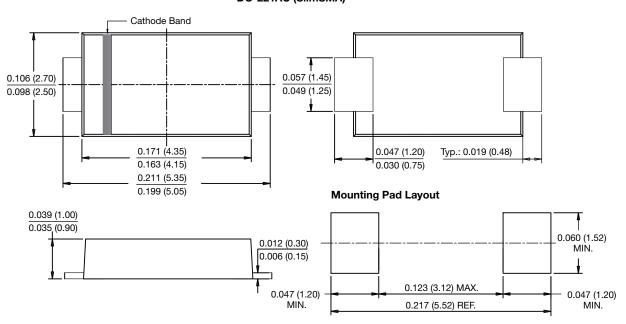


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Area

### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### DO-221AC (SlimSMA)





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